Type C1F Surface Mount Fast Acting Chip Fuse



HF 6 C1F Series – 1206 Size

RoHS 2 Compliant

Features

- Fast Acting, with improved surge withstand performance
- Small size, 1206 SMD
- Current rating from 250mA to 8A, fuse marked with ampere code
- Wide operating temperature range from -55°C to 125°C
- Tape and Reel for automatic SMD placement
- Compatible with 260°C IR Pb-free and wave soldering process
- AEC-Q Compliant
- RoHS 2 compliant (MSL = 1)
- Halogen Free
- Lead Free
- Meets Bel automotive qualification*
- * Largely based on internal AEC-Q test plan

Applications

- Automotive Navigation System
- Thin film transistor LCD flat-panel display screen
- Notebook
- PC computer
- Office electronic equipment
- Industrial equipment
- Medical equipment
- POE, POE+
- LCD / LED monitor
- Power supply
- LCD / LED TV
- DC-DC Converter





marked with marking code.

Example:

Typical Part Marking

Fuse body (ceramic white side)

c**93**°us ∈ €

AEC-Q Compliant

Current Rating	Marking Code	Current Rating	Marking Code
250mA	Е	2.5A	Т
375mA	Н	3A	3
500mA	J	3.5A	Z
750mA	М	4A	4
1A	1	5A	5
1.25A	Р	6A	6
1.5A	R	7A	7
2A	2	8A	8

Electrical Characteristics (UL STD. 248-14)

Tastia a Occasa	Blow Time		
Testing Current	Minimum	Maximum	
100%	4 Hrs.	N/A	
200%	N/A	5 Sec	
300%	N/A	0.2 Sec	

Safety Agency Approvals

Safety Agency	Safety Agency Certificate	Voltage Rating (V)	Ampere Range / Volt @ I.R. ability*		
c 'Rl °us	E20624	250mA-8A/125V AC /63V DC	250mA-6A/100A @ 125V AC /50A@ 63V DC 7A-8A/35A @ 125V AC /50A@ 63V DC		
*LP = Interrupting Pating = Short Circuit Pating(Amps)					

Physical Specifications

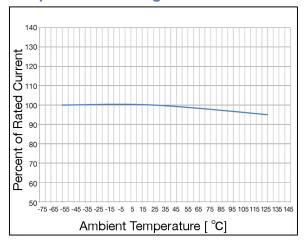
	Body : Ceramic Substrate
Materials	Terminations : Ag / Ni / Sn (100% Lead-free)
	Element Cover Coating : Lead-free Glass
	On Fuse :
	Marking Code
Marking	On Label :
	"bel", "C1F", "Current Rating", "Voltage Rating", "Interrupting Rating",
	"Appropriate Safety Logos" and " 💜 ", " 😉 "(China RoHS compliant).

Specifications subject to change without notice

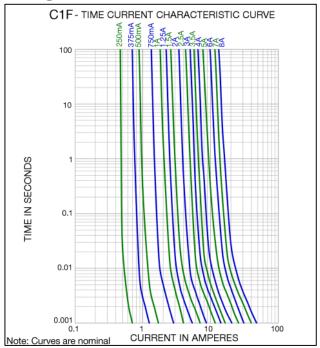


Type C1F

Temperature Derating Curve



Average Time Current Curve



Electrical Specifications

Part Number	Ampere Rating (A)	Marking Code	Nominal Cold Resistance (ohms)	Maximum Volt-drop @100% In (Volt) max.	Voltage and Interrupting Ratings	Nominal Melting I²T @10 In (A² Sec)	Maximum Power Dissipation @100% In (W)	Agency Approvals
0685F0250-XX	250mA	Е	2.30	0.813		0.0002	0.20	Y
0685F0375-XX	375mA	Н	1.25	0.789		0.0007	0.30	Y
0685F0500-XX	500mA	J	0.87	0.693		0.0015	0.35	Y
0685F0750-XX	750mA	М	0.43	0.476		0.0051	0.36	Y
0685F1000-XX	1A	1	0.28	0.421	See Table of	0.012	0.42	Υ
0685F1250-XX	1.25A	Р	0.210	0.411		0.023	0.51	Y
0685F1500-XX	1.5A	R	0.165	0.400	Safety Approvals	0.040	0.60	Y
0685F2000-XX	2A	2	0.068	0.194	on Page 1 for Voltage and	0.085	0.39	Y
0685F2500-XX	2.5A	Т	0.049	0.198	associated	0.15	0.50	Υ
0685F3000-XX	3A	3	0.039	0.166	Interrupting	0.19	0.50	Υ
0685F3500-XX	3.5A	Z	0.032	0.164	Ratings	0.21	0.57	Y
0685F4000-XX	4A	4	0.026	0.164		0.33	0.66	Y
0685F5000-XX	5A	5	0.020	0.164		0.83	0.82	Υ
0685F6000-XX	6A	6	0.015	0.163		1.3	0.98	Y
0685F7000-XX	7A	7	0.012	0.154]	2.2	1.08	Y
0685F8000-XX	8A	8	0.010	0.148		3.5	1.18	Υ

Consult manufacturer for other ratings

NOTES: Test Conditions

All test for ratings 250mA - 5A were conducted with fuse samples soldered on a PCB (1.6mm thick) test board with copper traces measuring 0.035 mm (35µm) nominal thickness (1 oz. clad), 5mm wide and 100mm overall length.

All test for ratings 6A-8A were conducted with fuse samples soldered on a PCB (1.6mm thick) test board with copper traces measuring 0.070 mm (70µm) nominal thickness (2 oz. clad), 7.5mm wide and 100mm overall length.

Device designed to be mounted with marking facing up.

Device designed to carry rated current for 4 hours minimum. It is recommended that device be operated continuously at no more than 80% of rated current when in a +25°C ambient, with further derating at elevated ambient temperatures.



Specifications subject to change without notice

Bel Fuse Inc. 206 Van Vorst Street Jersey City, NJ 07302 USA +1 201.432.0463 Bel.US.CS@belf.com belfuse.com/circuit-protection Type C1F

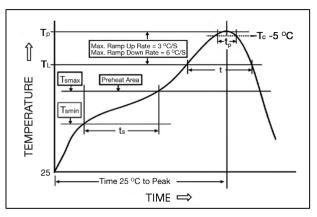
Environmental Specifications

Shock Resistance	MIL-STD-202G, Method 213B, Test Condition 1 (100 G's peak for 6 milliseconds; Sawtooth waveform)		
Vibration Resistance	MIL-STD-202G, Method 201A (10-55 Hz, 0.06 inch, total excursion).		
Salt Spray Resistance	MIL-STD-202G, Method 101E, Test Condition B (48 hrs.).		
Insulation Resistance	MIL-STD-202G, Method 302, Test Condition A (After Opening) 10,000 ohms minimum.		
Solderability	MIL-STD-202G, Method 208H		
Resistance to solder Heat	MIL-STD-202G, Method 210F, Test Condition C. Top Side(260°C,20 sec) MIL-STD-202G, Method 210F, Test Condition D. Bottom Side(260°C,10 sec)		
Thermal Shock	MIL-STD-202G, Method 107G, Test Condition B (-65 $^{\circ}$ C to +125 $^{\circ}$ C).		
Operating Temperature	-55℃ to +125℃		
Moisture Sensitivity	1 (According to IPC J-Std-020)		

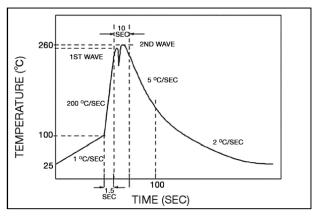
High temperature storage	MIL-STD-202 Method 108	
Temperature cycling	JESD22 Method JA-104,Test Condition B	
Biased humidity	MIL-STD-202 Method 103, 85C/85% RH with 10% operating power for 1000 hrs.	
Operational life	MIL-STD-202 Method 108, Test Condition D	
Resistance to solvents	MIL-STD-202 Method 215	
Mechanical shock	MIL-STD-202 Method 213,Test Condition C	
Vibration	MIL-STD-202 Method 204	
Resistance to soldering heat	MIL-STD-202 Method 210,Test condition B	
Thermal shock	MIL-STD-202 Method 107	
Solderability	J-STD-002	
Board flex(SMD)	AEC-Q200-005	
Terminal strength	AEC-Q200-006	
Electrical characterization	3 temperature electrical	

Soldering Parameters

IR Reflow Profile (IPC/JEDEC J-STD-020D)			
Preheat & Soak Temperature min (T _{smin}) Temperature max (T _{smax}) Time (T _{smin} to T _{smax}) (t _s)	150°C 200°C 60-120 seconds		
Average ramp-up rate (T _{smax} to T _p)	3°C/second max.		
Liquidous temperature (T _L) Time at liquidous (t _L)	217℃ 60-150 seconds		
Peak temperature (T _p)	260°C max		
Time (tp) within 5°C of the specified classification temperture (Tc)	30 seconds		
Average ramp-down rate (T _p to T _{smax})	6°C/second max.		
Time 25℃ to peak temperature	8 minutes max.		



Lead-free Wave Soldering Profile			
Wave Soldering Parameter			
Average ramp-up rate	200°C / second		
Heating rate during preheat	typical 1 - 2°C / second Max 4°C / second		
Final preheat temperature	within 125°C of soldering temperature		
Peak temperature Tp	260℃		
Time within +0°C / -5°C of actual peak temperature	10 seconds		
Ramp-down rate	5℃ / second max.		





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Bel Fuse Inc. 206 Van Vorst Street Jersey City, NJ 07302 USA

Rev. C1F Jan2019

Type C1F

Fuse FGNO Explanation 0685 F [XXXX] -XX

0685F=C1F; [XXXX]=Ampere Rating; XX=See Ordering Information as below

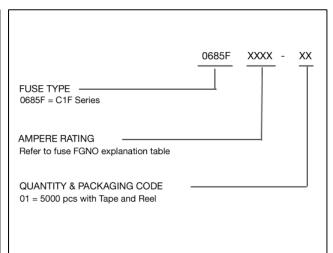
Fraction	Decimal	Milliamps	Bel FGNO[XXXX]
1/4	0.250	250	0250
3/8	.375	375	0375
1/2	.500	500	0500
3/4	.750	750	0750

Fraction	Decimal	Amps	Bel FGNO[XXXX]
	1.0	1	1000
1-1/4	1.25	1.25	1250
1-1/2	1.50	1.5	1500
	2.0	2	2000
2-1/2	2.5	2.5	2500
	3.0	3	3000
3-1/2	3.5	3.5	3500
	4.0	4	4000
	5.0	5	5000
	6.0	6	6000
	7.0	7	7000
	8.0	8	8000

Mechanical Dimensions

воттом TOP 0.51mm±0.25mm (0.020"±0.010") MARKING CODE 1.58mm±0.20mm (0.062''±0.008'') 3.20mm±0.20mm (0.126"±0.008") 0.63mm±0.20mm (0.025"±0.008") RECOMMENDED PAD LAYOUT C1F 1.52mm (0.060'') 1.52mm 1.78mm (0.070'') 2.03mm (0.080'') 1.14mm (0.045'') 1.52mm (0.060'') INFRARED REFLOW WAVE SOLDER

Ordering Information



Packaging

Packaging Tape & Reel	Packaging Specification	Quantity	Quantity & Packaging Code
8 mm wide tape with 7 inches Diameter reel	EIA Standard 481-E	5000	0685FXXXX-01



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Rev. C1F Jan2019